

EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	2384	333/202	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/18 08:30
L2	4161	((333/202) or (333/227) or (333/230) or (333/246) or (333/247)).CCLS.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/06/18 08:31
L3	2231	2 and (wafer layer substrate sheet)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/18 08:31
L4	1174	3 and (opening aperture cavity pit orifice)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/18 08:32
L5	1475	3 and (opening aperture cavity pit orifice gap)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/18 08:33
L6	1437	5 and (conductor line stripline microstrip trace pattern)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/18 08:33
L7	1310	6 and (metal\$4 conductive)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/18 08:34
L8	1049	7 and (via hole)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/18 08:38

L9	13286	((wafer layer substrate sheet) and (opening aperture cavity pit orifice gap) and (conductor line stripline microstrip trace pattern) and (metal\$4 conductive) and (via hole)).clm.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/18 09:21
L10	417	9 and "333"/\$. ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/18 09:22
L11	5012	((multiple plurality third three) near3 (wafer layer substrate sheet) and (opening aperture cavity pit orifice gap) and (conductor line stripline microstrip trace pattern) and (metal\$4 conductive) and (via hole)).clm.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/18 09:23
L12	1905	((multiple plurality third three) near3 (wafer layer substrate sheet) with (opening aperture cavity pit orifice gap) and (conductor line stripline microstrip trace pattern) and (metal\$4 conductive) and (via hole)).clm.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/18 09:24

L13	1213	((multiple plurality third three) near3 (wafer layer substrate sheet) with (opening aperture cavity pit orifice gap) and (conductor line stripline microstrip trace pattern) and (metal\$4 conductive) with (via hole)).clm.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/18 09:25
L14	100	13 and (resonator resonance resonant\$4)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/18 09:26

6/18/08 9:30:59 AM

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